

STPS20SM60S

Power Schottky rectifier

Features

- High current capability
- Avalanche rated
- Low forward voltage drop
- High frequency operation

Description

The STPS20SM60S is a single Schottky diode, suited for high frequency switch mode power supply.

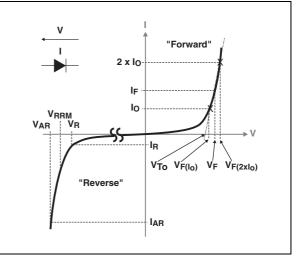
Packaged in TO-220AB, I²PAK and D²PAK, this device is intended to be used in notebook, game station and desktop adapters, providing in these aplications a good efficiency at both low and high load.

Table 1. Device summary				
Symbol	Value			
I _{F(AV)}	20 A			
V _{RRM}	60 V			
V _F (typ)	0.410 V			
T _i (max)	150 °C			

A

TO-220AB STPS20SM60ST





 V_{ARM} and I_{ARM} must respect the reverse safe operating area defined in *Figure 12*. V_{AR} and I_{AR} are pulse measurements (t_p < 1 μs). V_R, I_R, V_{RRM} and V_F, are static characteristics

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Characteristics 1

Absolute ratings (limiting values with terminals 1 and 3 short circuited at Table 2. T_{amb} = 25 °C, unless otherwise specified)

Symbol		Value	Unit			
V _{RRM}	Repetitive peak reverse vo	oltage			60	V
I _{F(RMS)}	Forward rms current				60	А
I _{F(AV)}	Average forward current, a	δ = 0.5	T _c = 130 °C	Per package	20	А
I _{FSM}	Surge non repetitive forwa	ard current	400	А		
P _{ARM} ⁽¹⁾	Repetitive peak avalanche	e power	18400	W		
V _{ARM} ⁽²⁾	Maximum repetitive peak avalanche voltage	t _p < 1 μs, T _j <	80	V		
V _{ASM} ⁽²⁾	Maximum single-pulse peak avalanche voltage	t _p < 1 μs, Τ _j <	80	v		
T _{stg}	Storage temperature rang	age temperature range				
Тj	Maximum operating juncti		150	°C		

For temperature or pulse time duration deratings, please refer to *Figure 4* and *5*. More details regarding the avalanche energy measurements and diode validation in the avalanche are provided in the application notes AN1768 and AN2025.

2. See Figure 12

 $\frac{dPtot}{dTj} < \frac{1}{Rth(j-a)}$ condition to avoid thermal runaway for a diode on its own heatsink З.

Table 3. Thermal resistance

Symbol	Parameter	Value	Unit
R _{th(j-c)}	Junction to case	1.3	°C/W

Table 4. Static electrical characteristics (terminals 1 and 3 short circuited)

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I _B ⁽¹⁾	Reverse leakage	T _j = 25 °C	V V	-	20	85	μΑ
'R'	current $T_j = 125 \text{ °C}$	current $T_j = 125 \text{ °C}$	= 125 °C $V_{\rm R} = V_{\rm RRM}$	-	15	50	mA
		$T_j = 25 ^{\circ}C$	-	0.495	0.535		
V _F ⁽²⁾	Forward voltage drop	T _j = 125 °C	$T_j = 125 \text{ °C}$ $I_F = 10 \text{ A}$	-	0.410	0.460	v
VF Forward voltage drop	T _j = 25 °C	I _F = 20 A	-	0.570	0.630	v	
	T _j = 125 °C	F = 20 A	-	0.510	0.580		

1. Pulse test: t_p = 5 ms, δ < 2 %

2. Pulse test: t_p = 380 µs, δ < 2 %

To evaluate the conduction losses use the following equation: P = 0.430 x $I_{F(AV)}$ + 0.0075 x ${I_F}^2_{(RMS)}$



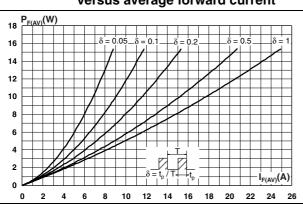
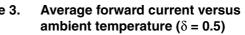


Figure 2. Average forward power dissipation Figure 3. versus average forward current



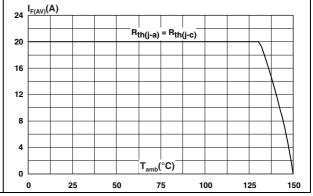


Figure 4. Normalized avalanche power derating versus pulse duration

Figure 5. Normalized avalanche power derating versus junction temperature

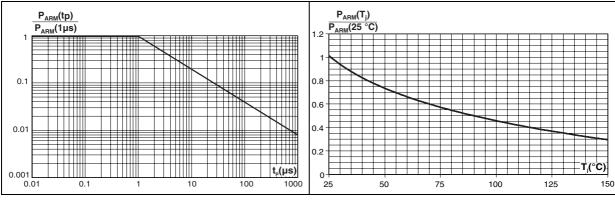


Figure 6. Non repetitive surge peak forward current versus overload duration (maximum values)

Figure 7. Relative variation of thermal impedance junction to case versus pulse duration

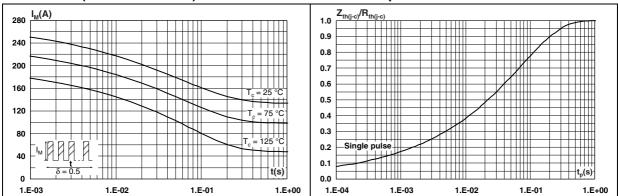
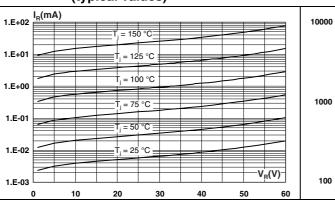


Figure 8. Reverse leakage current versus reverse voltage applied (typical values)



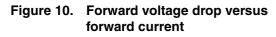


Figure 9. Junction capacitance versus reverse voltage applied (typical values)

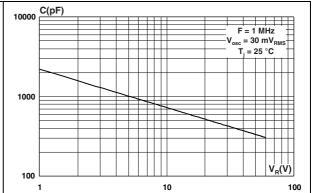
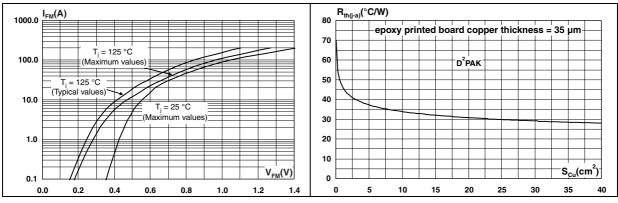
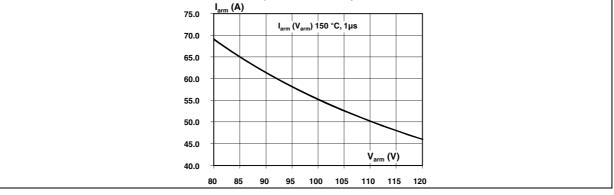


Figure 11. Thermal resistance junction to ambient versus copper surface under tab









2 Package information

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)
- Recommended torque value: 0.4 to 0.6 N·m

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Table 5. TO-220AB dimensions

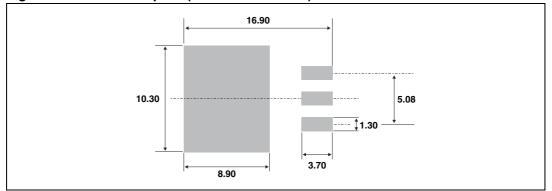
				Dimer	nsions	
		Ref.	Millin	neters	Inc	hes
			Min.	Max.	Min.	Max.
		А	4.40	4.60	0.173	0.181
		С	1.23	1.32	0.048	0.051
H2 Dia	A	D	2.40	2.72	0.094	0.107
		Е	0.49	0.70	0.019	0.027
	L7	F	0.61	0.88	0.024	0.034
L6		F1	1.14	1.70	0.044	0.066
		F2	1.14	1.70	0.044	0.066
F2		G	4.95	5.15	0.194	0.202
	D ←→_	G1	2.40	2.70	0.094	0.106
L4		H2	10	10.40	0.393	0.409
F → ←		L2	16.4	Тур.	0.645	5 Тур.
G1	M =	L4	13	14	0.511	0.551
G	l ←→ E → I ←	L5	2.65	2.95	0.104	0.116
G		L6	15.25	15.75	0.600	0.620
		L7	6.20	6.60	0.244	0.259
		L9	3.50	3.93	0.137	0.154
		М	2.6	Тур.	0.102	2 Тур.
		Dia.	3.75	3.85	0.147	0.151



				Dimer	nsions	
		Ref.	Millim	neters	Inc	hes
			Min.	Max.	Min.	Max.
		А	4.40	4.60	0.173	0.181
	<u>→</u>	A1	2.49	2.69	0.098	0.106
		A2	0.03	0.23	0.001	0.009
		В	0.70	0.93	0.027	0.037
с		B2	1.14	1.70	0.045	0.067
		С	0.45	0.60	0.017	0.024
		C2	1.23	1.36	0.048	0.054
$\xrightarrow{B2}$		D	8.95	9.35	0.352	0.368
G		Е	10.00	10.40	0.393	0.409
		G	4.88	5.28	0.192	0.208
		L	15.00	15.85	0.590	0.624
	M↓ ★↓ V2	L2	1.27	1.40	0.050	0.055
	* FLAT ZONE NO LESS THAN 2mm	L3	1.40	1.75	0.055	0.069
	TEAT ZONE NO LEGS THAN ZIIIII	М	2.40	3.20	0.094	0.126
		R	0.40	typ.	0.01	6 typ.
		V2	0°	8°	0°	8°

Table 6.D²PAK dimensions

Figure 13. D²PAK footprint (dimensions in mm)





			Dimensions			
		Ref.	Millin	neters	Inches	
			Min.	Max.	Min.	Max.
	А	4.40	4.60	0.173	0.181	
		A1	2.40	2.72	0.094	0.107
	b	0.61	0.88	0.024	0.035	
	D	b1	1.14	1.70	0.044	0.067
		с	0.49	0.70	0.019	0.028
	$L = \frac{b1}{b1}$	c2	1.23	1.32	0.048	0.052
		D	8.95	9.35	0.352	0.368
		е	2.40	2.70	0.094	0.106
		e1	4.95	5.15	0.195	0.203
	→ C	E	10	10.40	0.394	0.409
l≪ e1		L	13	14	0.512	0.551
		L1	3.50	3.93	0.138	0.155
		L2	1.27	1.40	0.050	0.055

Table 7.I²PAK dimensions



3 Ordering information

Table 8.Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS20SM60ST	STPS20SM60ST	TO-220AB	2.2 g	50	Tube
STPS20SM60SR	STPS20SM60SR	I ² PAK	1.49 g	50	Tube
STPS20SM60SG-TR	STPS20SM60SG	D ² PAK	1.48 g	1000	Tape and reel

4 Revision history

Table 9.Revision history

Date	Revision	Changes
10-Oct-2011	1	Initial release.



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